

April 8, 2004

To: Commissioner of Patents and Trademarks
Washington; D.C. 20231

Fr: George O. Saile Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Divisional Patent Application of
Serial No.: 10/205,520 7/25/02

YI-HSU WU,JIAN-HSING LEE,SHUI-HUNG CHEN
WHOLE CHIP ESD PROTECTION

PRELIMINARY AMENDMENT

Dear Sir:

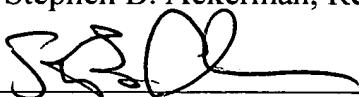
This is a preliminary amendment for the above referenced Divisional Patent Application. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on April 8, 2004.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



4/8/04